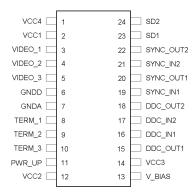


## **VGA PORT COMPANION CIRCUIT**

#### **Features**

- 7 channels of ESD protection for all VGA port connector pins meeting IEC-61000-4-2 Level-4 ESD requirements (8KV contact discharge)
- Very low loading capacitance from ESD protection diodes on VIDEO lines, 4pF typical
- TTL to CMOS level-translating buffers with power down mode for HSYNC and VSYNC lines
- 75  $\Omega$  termination resistors for VIDEO lines (matched to 1% typ.)
- Bi-directional level shifting N-channel FETs provided for DDC CLK & DDC DATA channels
- · Compact 24-pin QSOP package

#### Pin Diagram



24-PIN QSOP PACKAGE

### **Product Description**

The PACVGA200 incorporates 7 channels of ESD protection for all signal lines commonly found in a VGA port. ESD protection is implemented with current steering diodes designed to safely handle the high surge currents encountered with IEC-1000-4-2 Level-4 ESD Protection (8KV contact discharge). When a channel is subjected to an electrostatic discharge, the ESD current pulse is diverted via the protection diodes into the positive supply rail or ground where it may be safely dissipated.

Separate positive supply rails are provided for the VIDEO, DDC and SYNC channels to facilitate interfacing with low voltage Video Controller ICs and provide design flexibility in multi-supply-voltage environments.

Two non-inverting drivers provide buffering for the HSYNC and VSYNC signals from the Video Controller IC (SYNC1, SYNC2). These buffers accept TTL input levels and convert them to CMOS output levels that swing between Ground and  $V_{CC4}$ . These drivers have nominal  $60\Omega$  output impedance to match the characteristic impedance of the HSYNC & VSYNC lines of the video cables typically used in PC applications.

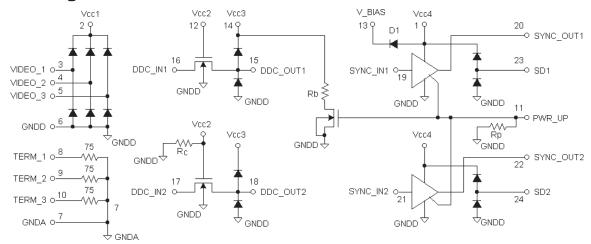
Two N-channel FETs provide the level shifting function required when the DDC controller is operated at a lower supply voltage than the monitor.

Three  $75\Omega$  termination resistors suitable for terminating the video signals from the video DAC are also provided. These resistors have separate input pins to allow insertion of additional EMI filtering, if required, between the termination point and the ESD protection diodes. These resistors are matched to better than 2% for excellent signal level matching for the R/G/B signals.

When the PWR\_UP input is driven LOW the SYNC inputs can be floated without causing the SYNC buffers to draw any current from the  $V_{CG}$  supply. When the PWR\_UP input is LOW the SYNC outputs are driven LOW.

An internal diode (D1 in schematic below) is also provided so that  $V_{CG}$  can be derived from  $V_{CG4}$ , if desired, by connecting  $V_{CG3}$  to  $V_{BIAS}$ . In applications where  $V_{CC4}$  may be powered down, diode D1 blocks any DC current paths from the DDC\_OUT pins back to the powered down  $V_{CG4}$  rail via the top ESD protection diodes.

#### **Schematic Diagram**



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ABSOLUTE MAXIMUM RATINGS					
Parameter	Rating	Unit			
$V_{CC1}$ , $V_{CC2}$ , $V_{CC3}$ & $V_{CC4}$ supply voltage	GND-0.5, +6.0	V			
Diode D1 forward current	100	uA			
DC voltage at inputs:		V			
VIDEO_1, VIDEO_2, VIDEO_3	GND-0.5, V <sub>CC1</sub> +0.5	V			
TERM_1, TERM_2, TERM_3	-6.0, +6.0	V			
DDC_IN1, DDC_IN2	GND-0.5, V <sub>CC2</sub> +0.5				
DDC_OUT1, DDC_OUT2	GND-0.5, V <sub>CC3</sub> +0.5	V			
SYNC_IN1, SYNC_IN2	GND-0.5, V <sub>CC4</sub> +0.5	V			
Temperature:					
Storage	-40 to +150	∘C			
Operating Ambient	0 to +70	∘C			
Package power dissipation	1.0	W			

		ICAL OPERATING CHARACTERISTI ting conditions unless specified other				
Symbol	Parameter	Conditions	MIN	TYP	MAX	UNIT
I <sub>CC1</sub>	V <sub>CC1</sub> supply current	$V_{CC1} = 5V$ ; VIDEO inputs at $V_{CC1}$ or GND			10	uA
I <sub>CC2, 3</sub>	V <sub>CC2</sub> , V <sub>CC3</sub> supply current	$V_{CC} = V_{CC3} = 5V$			10	uA
I <sub>CC4</sub>	V <sub>CC4</sub> supply current	$V_{CC4} = 5V$ ; SYNC inputs at GND or $V_{CC4}$ ;		10		uA
	ω <sub>4</sub> - γ <sub>1</sub> γ <sub>1</sub> γ · γ · γ · γ	PWR_UP pin at V <sub>CC4</sub> . SYNC outputs unloaded				
		$V_{CC4} = 5V$ ; SYNC inputs at 3.0V; PWR_UP		200		uA
		pin at V <sub>CC4</sub> ; SYNC outputs unloaded				
		V <sub>CC4</sub> = 5V; PWR_UP input at GND; SYNC			10	uA
		outputs unloaded				
V <sub>BIAS</sub>	V <sub>BIAS</sub> open circuit voltage	No external current drawn from V <sub>BIAS</sub> pin		V <sub>CC4</sub> -0.8		V
R <sub>T</sub>	VIDEO termination resistance		71.25	75	78.75	Ω
	R <sub>T</sub> resistance matching			1	2	%
V <sub>IH</sub>	Logic High input voltage <sup>1</sup>	$V_{CC4} = 5.0V$	2.0			V
V <sub>IL</sub>	Logic Low input voltage <sup>1</sup>	$V_{CC4} = 5.0V$			0.8	V
V <sub>OH</sub>	Logic High output voltage1	$I_{OH} = -4 \text{mA}, V_{CC4} = 5.0 \text{V}$	4.4			V
V <sub>OL</sub>	Logic Low output voltage1	$I_{OL} = 4mA, V_{CC4} = 5.0V$			0.4	V
R <sub>b</sub> , R <sub>p</sub>	Resistor value	PWR_UP, $V_{CC3} = 5.0V$	0.5	1	2	ΜΩ
$R_c$	V <sub>CC 2</sub> pull-down resistor	$V_{002} = 3.0V$	0.5	1.5	3	ΜΩ
I <sub>N</sub>	Input current					
	VIDEO inputs	$V_{CC1} = 5V$ ; $V_{IN} = V_{CC1}$ or GND			±1	μΑ
	HSYNC, VSYNC inputs	$V_{CC4} = 5V$ ; $V_{IN} = V_{CC4}$ or GND			±1	μΑ
I <sub>OFF</sub>	OFF state leakage current, level	$(V_{CC2} - V_{DDC   IV}) \le 0.4V; V_{DDC_{QUT}} = V_{CC2}$			10	μΑ
	shifting NFET	$(V_{CC} - V_{DDC, CLIT}) \le 0.4V; V_{DDC_LIN} = V_{CC}$			10	μА
V <sub>ON</sub>	Voltage drop across level	$V_{CC2} = 2.5V$ ; $V_S = GND$ , $I_{DS} = 3mA$			0.15	V
GN	shifting NFET when turned ON					
C <sub>IN</sub>	Input capacitance 3					
	VIDEO_1, VIDEO_2, VIDEO_3	$V_{CC1} = 5.0V$ ; $V_{IN} = 2.5V$ ; measured at 1MHz		4.0		рF
		$V_{CC1} = 2.5V$ ; $V_{IN} = 1.25V$ ; measured at 1MHz		4.5		
t <sub>PLH</sub>	SYNC drivers L-H propagation delay	$C_L = 50 \text{ pF}; V_{CC} = 5V; \text{ Input } t_r \text{ and } t_f \leq 5 \text{ ns}$		8	12	ns
t <sub>PHL</sub>	SYNC drivers H-L propagation delay	$C_L = 50 \text{ pF}; V_{CC} = 5V; \text{ Input } t_r \text{ and } t_f \leq 5 \text{ns}$		8	12	ns
t <sub>r</sub> , t <sub>f</sub>	SYNC drivers output rise & fall times	$C_L = 50 \text{ pF}; V_{CC} = 5V; \text{ Input } t_r \text{ and } t_f \leq 5 \text{ns}$		7		ns
V <sub>ESD</sub>	ESD withstand voltage <sup>2, 3</sup>	$V_{CC1} = V_{CC3} = V_{CC4} = 5V$	±8			kV

Note 1: These parameter applies only to the HSYNC and VSYNC channels.

Note 2: Per the IEC-61000-4-2 International ESD Standard, Level 4 contact discharge method.  $V_{\rm CCP}$ ,  $V_{\rm CC3}$  and  $V_{\rm CC4}$  must be bypassed to GND via a low impedance ground plane with a 0.2uF, low inductance, chip ceramic capacitor at each supply pin. ESD pulse is applied between the applicable pins and GND. ESD pulse can be positive or negative with respect to GND. Applicable pins are: VIDEO\_1, VIDEO\_2, VIDEO\_3, SYNC\_OUT1, SD1, SYNC\_OUT2, SD2, DDC\_OUT1 and DDC\_OUT2. All other pins are ESD protected to the industry standard 2kV per the Human Body model (MIL-STD-883, Method 3015).

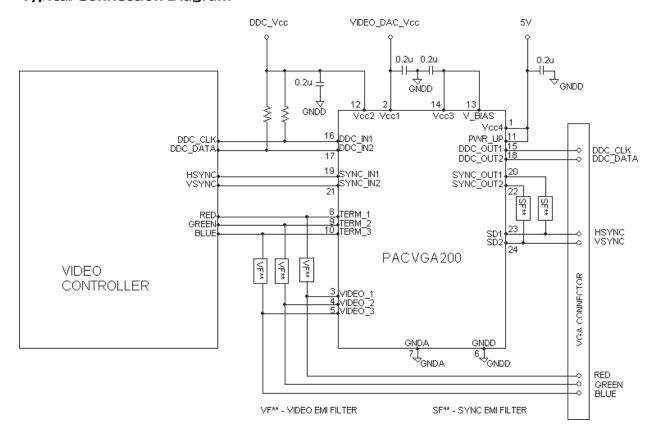
Note 3: This parameter is guaranteed by design and characterization.

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#### **Typical Connection Diagram**



A resistor may be necessary between the  $V_{CC3}$  pin and ground if protection against a stream of ESD pulses is required while the PACVGA200 is in the power-down state. The value of this resistor should be chosen such that the extra charge deposited into the  $V_{CC3}$  bypass capacitor by each ESD pulse will be discharged before the next ESD pulse occurs. The maximum ESD repetition rate specified by the IEC-61000-4-2 standard is one pulse per second. When the PACVGA200 is in the power-up state, an internal discharge resistor is connected to ground via an FET switch for this purpose.

For the same reason,  $V_{CC1}$  and  $V_{CC4}$  may also require bypass capacitor discharging resistors to ground if there are no other components in the system to provide a discharge path to ground.

GNDA, the reference voltage for the 75R resistors is not connected internally to GNDD and should ideally be connected to the ground of the video DAC IC.

STANDARD PART ORDERING INFORMATION				
Package		Ordering Part Number		
Pins	Style	Part Marking		
24	QSOP	PACVGA200Q		

When placing an order please specify desired shipping: Tubes or Tape & Reel.